July 2003

## FDS9926A

FAIRCHILD SEMICONDUCTOR®

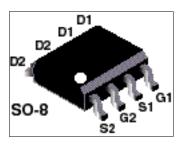
### Dual N-Channel 2.5V Specified PowerTrench<sup>o</sup> MOSFET

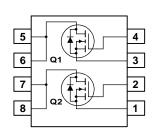
### **General Description**

These N-Channel 2.5V specified MOSFETs use Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 10V).

### Applications

- Battery protection
- Load switch
- Power management





### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage			20	V
V <sub>GSS</sub>	Gate-Source Voltage			±10	
D	Drain Curre	nt – Continuous	(Note 1a)	6.5	A
		– Pulsed		20	
P <sub>D</sub>	Power Dissipation for Dual Operation			2	W
	Power Dissipation for Single Operation (Note 1a)			1.6	
			(Note 1b)	1	
			(Note 1c)	0.9	
Γ <sub>J</sub> , T <sub>STG</sub>	Operating a	nd Storage Junction Temp	erature Range	-55 to +150	°C
Therma	l Charac	teristics	·		
R <sub>0JA</sub>	Thermal Re	sistance, Junction-to-Ambi	ent (Note 1a)	78	°C/W
S <sup>ejc</sup>	Thermal Re	Thermal Resistance, Junction-to-Case (Note 1)		40	
Packag	e Markin	g and Ordering l	nformation		
Device Marking		Device	Reel Size	Tape width	Quantity
FDS9926A		FDS9926A	13"	12mm	2500 units

©2003 Fairchild Semiconductor Corp.

Features

6.5 A, 20 V.

$$\begin{split} R_{\text{DS(ON)}} &= 30 \ \text{m}\Omega \ @ \ \text{V}_{\text{GS}} = 4.5 \ \text{V} \\ R_{\text{DS(ON)}} &= 43 \ \text{m}\Omega \ @ \ \text{V}_{\text{GS}} = 2.5 \ \text{V}. \end{split}$$

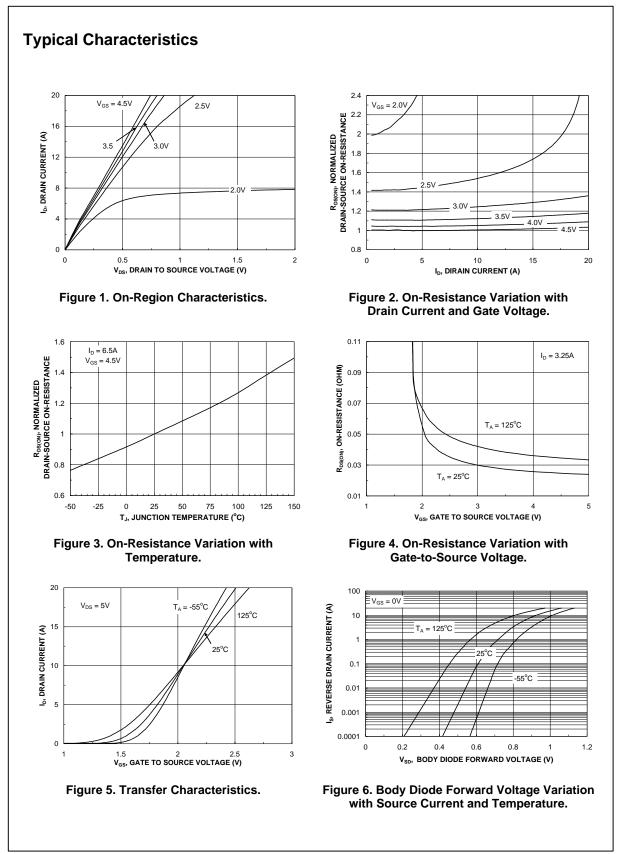
- Optimized for use in battery protection circuits
- Low gate charge

FDS9926A

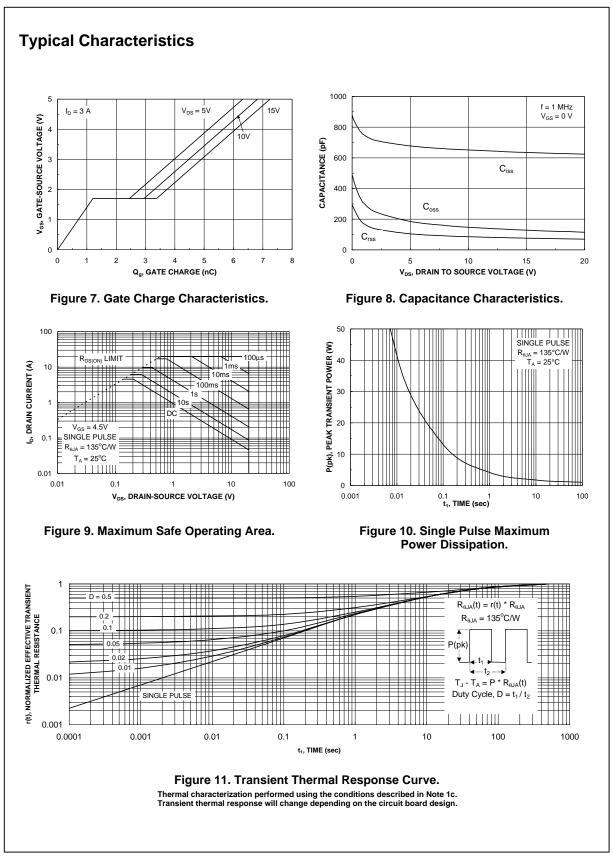
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		14		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V},  V_{GS} = 0 \text{ V}$			1	μA
I <sub>GSS</sub>	Gate–Body Leakage	$V_{GS} = \pm 8 \text{ V},  V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_{D} = 250 \ \mu A$	0.6	1	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-3		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = 4.5 \ V, & I_D = 6.5 \ A \\ V_{GS} = 2.5 \ V, & I_D = 5.4 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 6.5 \ A, \ T_J = 125^\circ C \end{array} $		25 35 35	30 43 50	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 4.5 \text{ V},  V_{DS} = 5 \text{ V}$	15			Α
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{\text{DS}} = 5 \text{ V}, \qquad I_{\text{D}} = 6.5 \text{ A}$		22		S
Dynamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = 10 V$ , $V_{GS} = 0 V$ ,		650		pF
Coss	Output Capacitance	f = 1.0 MHz		150		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1		85		pF
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> = 15 mV, f = 1.0 MHz		1.4		Ω
Switchin	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = 10 V$ , $I_D = 1 A$ ,		8	16	ns
t <sub>r</sub>	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		9	17	ns
t <sub>d(off)</sub>	Turn–Off Delay Time	1		15	26	ns
t <sub>f</sub>	Turn–Off Fall Time			4	9	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 10 V$ , $I_D = 3 A$ ,		6.2	9	nC
Q <sub>gs</sub>	Gate–Source Charge	V <sub>GS</sub> = 4.5 V		1.2		nC
Q <sub>gd</sub>	Gate-Drain Charge			1.7		nC
Drain-Se	ource Diode Characteristics ar	d Maximum Ratings				
V <sub>SD</sub>	Drain–Source Diode Forward Voltage			0.73	1.3	V
t <sub>rr</sub>	Diode Reverse Recovery Time	$I_F = 6.5 \text{ A},  d_{iF}/d_t = 100 \text{ A}/\mu\text{s}$		15		nS
Q <sub>rr</sub>	Diode Reverse Recovery Charge	1		5		nC

**2.** Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

FDS9926A Rev E (W)



# FDS9926A



FDS9926A

### TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™	FACT Quiet Series™	LittleFET™	Power247™	SuperSOT™-6
ActiveArray™	FAST®	MICROCOUPLER™	PowerTrench <sup>®</sup>	SuperSOT™-8
Bottomless™	FASTr™	MicroFET™	QFET <sup>®</sup>	SyncFET™
CoolFET™	FRFET™	MicroPak™	QS™	TinyLogic <sup>®</sup>
CROSSVOLT™	GlobalOptoisolator™	MICROWIRE™	QT Optoelectronics <sup>™</sup>	TINYOPTO™
DOME™	GTO™່	MSX™	Quiet Series <sup>™</sup>	TruTranslation™
EcoSPARK™	HiSeC™	MSXPro™	RapidConfigure™	UHC™
E <sup>2</sup> CMOS <sup>™</sup>	I <sup>2</sup> C <sup>™</sup>	OCX™	RapidConnect™	UltraFET <sup>®</sup>
EnSigna™	ImpliedDisconnect™	OCXPro™	SILENT SWITCHER®	VCX™
FACT™	ISOPLANAR™	<b>OPTOLOGIC<sup>®</sup></b>	SMART START™	
Across the boar	d. Around the world.™	OPTOPLANAR™	SPM™	
The Power Fran		PACMAN™	Stealth™	
Programmable A		POP™	SuperSOT™-3	

### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

### **PRODUCT STATUS DEFINITIONS**

**Definition of Terms** 

Product Status	Definition
Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.
	Formative or In Design First Production Full Production